

SURFACE MOUNT SCHOTTKY BARRIER DIODE ARRAY
Features

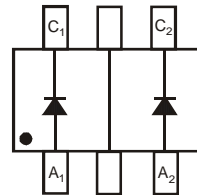
- Low Forward Voltage Drop
- Fast Switching
- Ultra-Small Surface Mount Package
- PN Junction Guard Ring for Transient and ESD Protection
- **Lead Free/RoHS Compliant (Note 3)**
- **"Green" Device (Note 4 and 5)**



Top View

Mechanical Data

- Case: SOT-363
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminals: Solderable per MIL-STD-202, Method 208
- Lead Free Plating (Matte Tin Finish annealed over Alloy 42 leadframe).
- Orientation: See Diagram
- Marking Information: See Page 3
- Ordering Information: See Page 3
- Weight: 0.006 grams (approximate)



(Jumper connection between middle pins)

Device Schematic

Maximum Ratings @ $T_A = 25^\circ\text{C}$ unless otherwise specified

| Characteristic | Symbol | Value | Unit |
|----------------------------------------------------|-----------|-------|------|
| Peak Repetitive Reverse Voltage | V_{RRM} | 30 | V |
| Working Peak Reverse Voltage | V_{RWM} | | |
| DC Blocking Voltage | V_R | | |
| Forward Continuous Current (Note 1) | I_F | 200 | mA |
| Repetitive Peak Forward Current (Note 1) | I_{FRM} | 300 | mA |
| Forward Surge Current (Note 1) @ $t < 1.0\text{s}$ | I_{FSM} | 600 | mA |

Thermal Characteristics

| Characteristic | Symbol | Value | Unit |
|------------------------------------------------------|-----------------|-------------|--------------------|
| Power Dissipation (Note 1) | P_D | 200 | mW |
| Thermal Resistance, Junction to Ambient Air (Note 1) | $R_{\theta JA}$ | 625 | $^\circ\text{C/W}$ |
| Operating and Storage Temperature Range | T_J, T_{STG} | -65 to +125 | $^\circ\text{C}$ |

Electrical Characteristics @ $T_A = 25^\circ\text{C}$ unless otherwise specified

| Characteristic | Symbol | Min | Typ | Max | Unit | Test Condition |
|------------------------------------|-------------|-----|-----|------|---------------|------------------------------------------------------------------------------------------|
| Reverse Breakdown Voltage (Note 2) | $V_{(BR)R}$ | 30 | — | — | V | $I_R = 100\mu\text{A}$ |
| Forward Voltage | V_F | — | — | 240 | mV | $I_F = 0.1\text{mA}$ |
| | | | | 320 | | $I_F = 1\text{mA}$ |
| | | | | 400 | | $I_F = 10\text{mA}$ |
| | | | | 500 | | $I_F = 30\text{mA}$ |
| | | | | 1000 | | $I_F = 100\text{mA}$ |
| Reverse Leakage Current (Note 2) | I_R | — | — | 2.0 | μA | $V_R = 25\text{V}$ |
| Total Capacitance | C_T | — | — | 10 | pF | $V_R = 1.0\text{V}, f = 1.0\text{MHz}$ |
| Reverse Recovery Time | t_{rr} | — | — | 5.0 | ns | $I_F = 10\text{mA}$ through $I_R = 10\text{mA}$ to $I_R = 1.0\text{mA}, R_L = 100\Omega$ |

- Notes:
1. Device mounted on FR-4 PC board with recommended pad layout, which can be found on our website at <http://www.diodes.com/datasheets/ap02001.pdf>.
 2. Short duration pulse test used to minimize self-heating effect.
 3. No purposefully added lead.
 4. Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com/products/lead_free/index.php.
 5. Product manufactured with Date Code UO (week 40, 2007) and newer are built with Green Molding Compound. Product manufactured prior to Date Code UO are built with Non-Green Molding Compound and may contain Halogens or Sb2O3 Fire Retardants.

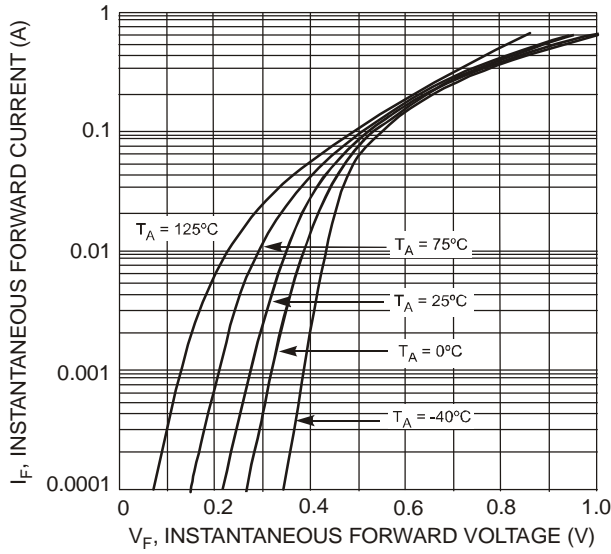


Fig. 1 Typical Forward Characteristics

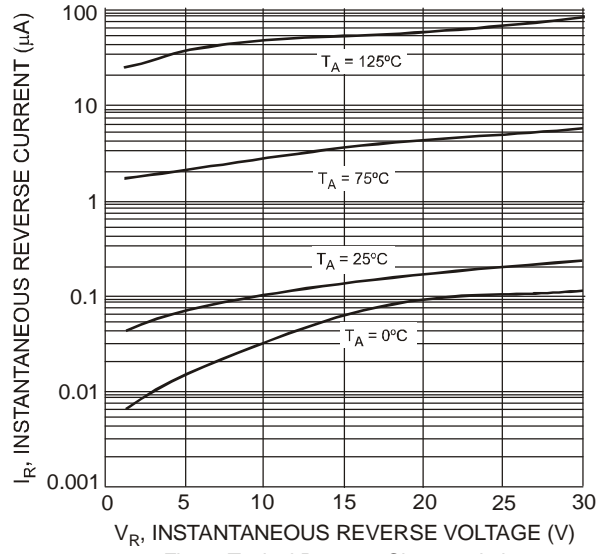


Fig. 2 Typical Reverse Characteristics

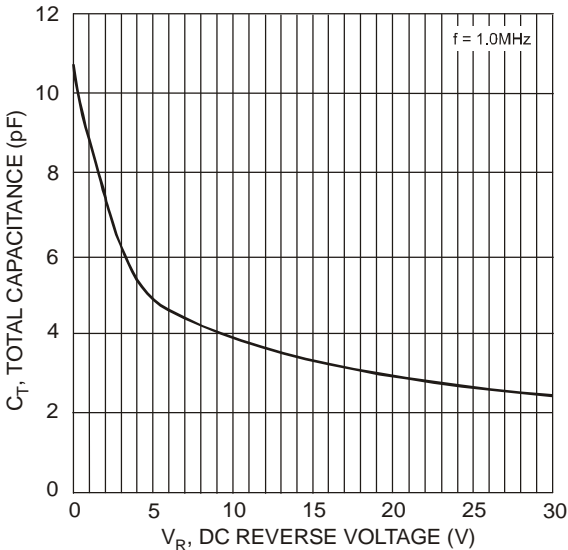


Fig. 3 Total Capacitance vs. Reverse Voltage

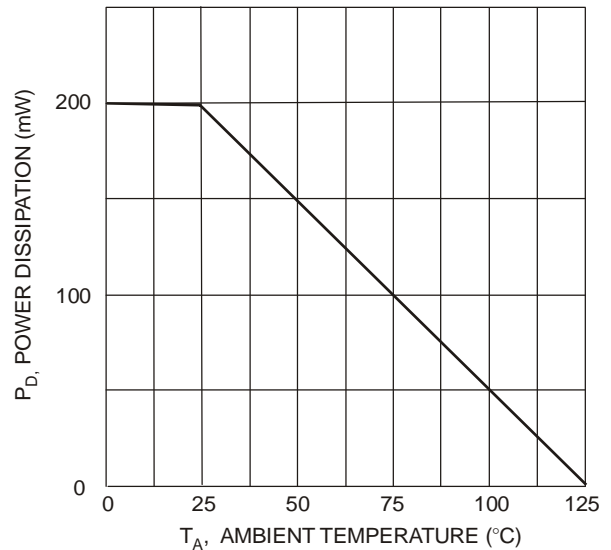


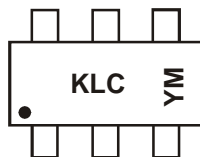
Fig. 4 Power Derating Curve

Ordering Information (Note 6)

| Part Number | Case | Packaging |
|-------------|---------|------------------|
| BAT54JW-7-F | SOT-363 | 3000/Tape & Reel |

Notes: 6. For packaging details, go to our website at <http://www.diodes.com/datasheets/ap02007.pdf>.

Marking Information



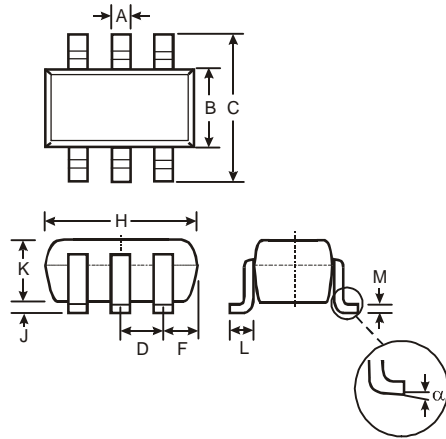
KLC = Product Type Marking Code
 YM = Date Code Marking
 Y = Year (ex: N = 2002)
 M = Month (ex: 9 = September)

Date Code Key

| Year | 2001 | 2002 | 2003 | 2004 | 2005 | 2006 | 2007 | 2008 | 2009 | 2010 | 2011 | 2012 | 2013 | 2014 | 2015 |
|------|------|------|------|------|------|------|------|------|------|------|------|------|------|------|------|
| Code | M | N | P | R | S | T | U | V | W | X | Y | Z | A | B | C |

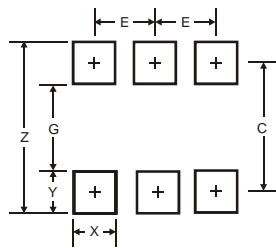
| Month | Jan | Feb | Mar | Apr | May | Jun | Jul | Aug | Sep | Oct | Nov | Dec |
|-------|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|
| Code | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | O | N | D |

Package Outline Dimensions



| SOT-363 | | |
|----------------------|----------|------|
| Dim | Min | Max |
| A | 0.10 | 0.30 |
| B | 1.15 | 1.35 |
| C | 2.00 | 2.20 |
| D | 0.65 Typ | |
| F | 0.40 | 0.45 |
| H | 1.80 | 2.20 |
| J | 0 | 0.10 |
| K | 0.90 | 1.00 |
| L | 0.25 | 0.40 |
| M | 0.10 | 0.22 |
| α | 0° | 8° |
| All Dimensions in mm | | |

Suggested Pad Layout



| Dimensions | Value (in mm) |
|------------|---------------|
| Z | 2.5 |
| G | 1.3 |
| X | 0.42 |
| Y | 0.6 |
| C | 1.9 |
| E | 0.65 |

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